

## N- and P-Channel 40-V (D-S) MOSFET

| PRODUCT SUMMARY |                     |                                    |                                 |                       |
|-----------------|---------------------|------------------------------------|---------------------------------|-----------------------|
|                 | V <sub>DS</sub> (V) | R <sub>DS(on)</sub> (Ω)            | I <sub>D</sub> (A) <sup>a</sup> | Q <sub>g</sub> (Typ.) |
| N-Channel       | 40                  | 0.0355 at V <sub>GS</sub> = 10 V   | 6.8                             | 5.3                   |
|                 |                     | 0.0425 at V <sub>GS</sub> = 4.5 V  | 6.2                             |                       |
| P-Channel       | - 40                | 0.035 at V <sub>GS</sub> = - 10 V  | - 7.2                           | 17                    |
|                 |                     | 0.047 at V <sub>GS</sub> = - 4.5 V | - 6.2                           |                       |

### FEATURES

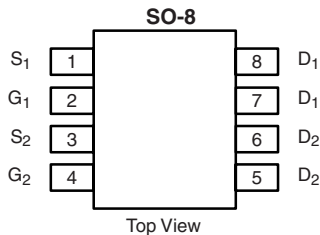
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET<sup>®</sup> Power MOSFET



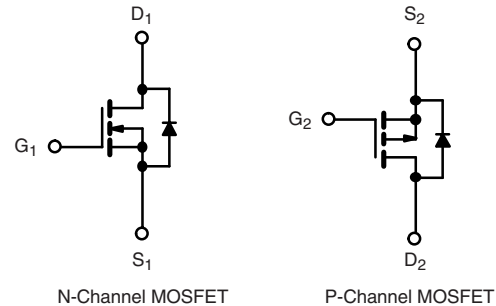
**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
Available

### APPLICATIONS

- Backlight Inverter for LCD Display



Ordering Information: Si4561DY-T1-E3 (Lead (Pb)-free)  
Si4561DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



| ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted |                                   |                        |                      |                       |                       |
|---|-----------------------------------|------------------------|----------------------|-----------------------|-----------------------|
| Parameter   | Symbol                            | N-Channel              | P-Channel            | Unit                  |                       |
| Drain-Source Voltage  | V <sub>DS</sub>                   | 40                     | - 40                 | V                     |                       |
| Gate-Source Voltage   | V <sub>GS</sub>                   | ± 20                   |                      |                       |                       |
| Continuous Drain Current (T <sub>J</sub> = 150 °C)                      | I <sub>D</sub>                    | T <sub>C</sub> = 25 °C | 6.8                  | - 7.2                 | A                     |
|   |                                   | T <sub>C</sub> = 70 °C | 5.4                  | - 5.7                 |                       |
|   |                                   | T <sub>A</sub> = 25 °C | 5.6 <sup>b, c</sup>  | - 5.6 <sup>b, c</sup> |                       |
|   |                                   | T <sub>A</sub> = 70 °C | 4.4 <sup>b, c</sup>  | - 4.4 <sup>b, c</sup> |                       |
| Pulsed Drain Current  | I <sub>DM</sub>                   | 20                     | - 20                 | A                     |                       |
| Source-Drain Current Diode Current                                      | I <sub>S</sub>                    | T <sub>C</sub> = 25 °C | 2.5                  |                       | - 2.5                 |
|   |                                   | T <sub>A</sub> = 25 °C | 1.6 <sup>b, c</sup>  |                       | - 1.6 <sup>b, c</sup> |
| Pulsed Source-Drain Current   | I <sub>SM</sub>                   | 20                     | - 20                 | mJ                    |                       |
| Single Pulse Avalanche Current  | I <sub>AS</sub>                   | 7                      | 15                   |                       |                       |
| Single Pulse Avalanche Energy   | E <sub>AS</sub>                   | 2.45                   | 11.25                | W                     |                       |
| Maximum Power Dissipation   | P <sub>D</sub>                    | T <sub>C</sub> = 25 °C | 3.0                  |                       | 3.3                   |
|   |                                   | T <sub>C</sub> = 70 °C | 1.9                  |                       | 2.10                  |
|   |                                   | T <sub>A</sub> = 25 °C | 2.0 <sup>b, c</sup>  |                       | 2.0 <sup>b, c</sup>   |
|   |                                   | T <sub>A</sub> = 70 °C | 1.25 <sup>b, c</sup> | 1.25 <sup>b, c</sup>  |                       |
| Operating Junction and Storage Temperature Range                        | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 150            |                      | °C                    |                       |

| THERMAL RESISTANCE RATINGS                  |              |                   |           |      |           |      |      |
|---|--------------|-------------------|-----------|------|-----------|------|------|
| Parameter                                   |              | Symbol            | N-Channel |      | P-Channel |      | Unit |
|   |              |                   | Typ.      | Max. | Typ.      | Max. |      |
| Maximum Junction-to-Ambient <sup>b, d</sup> | t ≤ 10 s     | R <sub>thJA</sub> | 54        | 64   | 50        | 62.5 | °C/W |
| Maximum Junction-to-Foot (Drain)            | Steady State | R <sub>thJF</sub> | 33        | 42   | 31        | 37   |      |

Notes:

- Based on T<sub>C</sub> = 25 °C.
- Surface Mounted on 1" x 1" FR4 board.
- t = 10 s.
- Maximum under Steady State conditions is 120 °C/W.

| <b>SPECIFICATIONS</b> $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted |                         |   |      |                   |        |                      |          |
|---|-------------------------|---|------|-------------------|--------|----------------------|----------|
| Parameter   | Symbol                  | Test Conditions   | Min. | Typ. <sup>a</sup> | Max.   | Unit                 |          |
| <b>Static</b>   |                         |   |      |                   |        |                      |          |
| Drain-Source Breakdown Voltage  | $V_{DS}$                | $V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$                             | N-Ch | 40                |        | V                    |          |
|   |                         | $V_{GS} = 0\text{ V}, I_D = -250\text{ }\mu\text{A}$                            | P-Ch | -40               |        |                      |          |
| $V_{DS}$ Temperature Coefficient  | $\Delta V_{DS}/T_J$     | $I_D = 250\text{ }\mu\text{A}$  | N-Ch |                   | 44     | mV/ $^\circ\text{C}$ |          |
|   |                         | $I_D = -250\text{ }\mu\text{A}$   | P-Ch |                   | -41    |                      |          |
| $V_{GS(th)}$ Temperature Coefficient  | $\Delta V_{GS(th)}/T_J$ | $I_D = 250\text{ }\mu\text{A}$  | N-Ch |                   | -5.5   |                      |          |
|   |                         | $I_D = -250\text{ }\mu\text{A}$   | P-Ch |                   | 4.3    |                      |          |
| Gate Threshold Voltage  | $V_{GS(th)}$            | $V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$                                 | N-Ch | 1.4               |        | 3.0                  |          |
|   |                         | $V_{DS} = V_{GS}, I_D = -250\text{ }\mu\text{A}$                                | P-Ch | -1.4              |        | -3.0                 |          |
| Gate-Body Leakage   | $I_{GSS}$               | $V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$                                 | N-Ch |                   |        | 100                  |          |
| Zero Gate Voltage Drain Current   | $I_{DSS}$               | $V_{DS} = 40\text{ V}, V_{GS} = 0\text{ V}$                                     | N-Ch |                   |        | 1                    |          |
|   |                         | $V_{DS} = -40\text{ V}, V_{GS} = 0\text{ V}$                                    | P-Ch |                   |        | -1                   |          |
|   |                         | $V_{DS} = 40\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$     | N-Ch |                   |        |                      | 10       |
|   |                         | $V_{DS} = -40\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$    | P-Ch |                   |        |                      | -10      |
| On-State Drain Current <sup>b</sup>   | $I_{D(on)}$             | $V_{DS} = 5\text{ V}, V_{GS} = 10\text{ V}$                                     | N-Ch | 10                |        | A                    |          |
|   |                         | $V_{DS} = -5\text{ V}, V_{GS} = -10\text{ V}$                                   | P-Ch | -10               |        |                      |          |
| Drain-Source On-State Resistance <sup>b</sup>                                   | $R_{DS(on)}$            | $V_{GS} = 10\text{ V}, I_D = 5\text{ A}$  | N-Ch |                   | 0.0295 | 0.0355               |          |
|   |                         | $V_{GS} = -10\text{ V}, I_D = -5\text{ A}$                                      | P-Ch |                   | 0.0285 | 0.035                |          |
|   |                         | $V_{GS} = 4.5\text{ V}, I_D = 4\text{ A}$                                       | N-Ch |                   | 0.0355 | 0.0425               |          |
|   |                         | $V_{GS} = -4.5\text{ V}, I_D = -4\text{ A}$                                     | P-Ch |                   | 0.037  | 0.047                |          |
| Forward Transconductance <sup>b</sup>   | $g_{fs}$                | $V_{DS} = 15\text{ V}, I_D = 5\text{ A}$  | N-Ch |                   | 22     | S                    |          |
|   |                         | $V_{DS} = -15\text{ V}, I_D = -5\text{ A}$                                      | P-Ch |                   | 20     |                      |          |
| <b>Dynamic<sup>a</sup></b>  |                         |   |      |                   |        |                      |          |
| Input Capacitance   | $C_{iss}$               | N-Channel<br>$V_{DS} = 20\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$      | N-Ch |                   | 640    | pF                   |          |
| Output Capacitance  | $C_{oss}$               |   | P-Ch |                   | 1555   |                      |          |
| Reverse Transfer Capacitance  | $C_{rss}$               | P-Channel<br>$V_{DS} = -20\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$     | N-Ch |                   | 73     |                      |          |
|   |                         |   | P-Ch |                   | 176    |                      |          |
| Total Gate Charge   | $Q_g$                   | $V_{DS} = 20\text{ V}, V_{GS} = 10\text{ V}, I_D = 5\text{ A}$                  | N-Ch |                   | 11.7   | 20                   |          |
|   |                         | $V_{DS} = -20\text{ V}, V_{GS} = -10\text{ V}, I_D = -5\text{ A}$               | P-Ch |                   | 38.5   | 60                   |          |
|   |                         | N-Channel<br>$V_{DS} = 20\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 5\text{ A}$    | N-Ch |                   | 5.3    | 9                    |          |
|   |                         |   | P-Ch |                   | 17     | 27                   |          |
| Gate-Source Charge  | $Q_{gs}$                | P-Channel<br>$V_{DS} = -20\text{ V}, V_{GS} = -4.5\text{ V}, I_D = -5\text{ A}$ | N-Ch |                   | 1.9    | nC                   |          |
| Gate-Drain Charge   | $Q_{gd}$                |   | P-Ch |                   | 4.2    |                      |          |
| Gate Resistance   | $R_g$                   | $f = 1\text{ MHz}$  | N-Ch |                   | 2.2    |                      | $\Omega$ |
|   |                         |   | P-Ch |                   | 3      |                      |          |



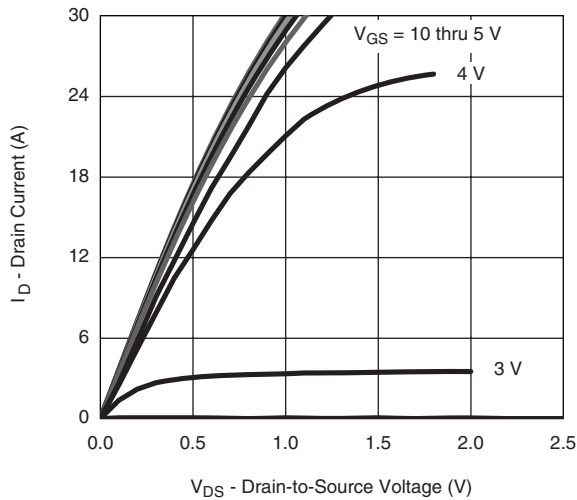
| <b>SPECIFICATIONS</b> $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted |              |   |      |                   |       |      |    |    |
|---|--------------|---|------|-------------------|-------|------|----|----|
| Parameter   | Symbol       | Test Conditions   | Min. | Typ. <sup>a</sup> | Max.  | Unit |    |    |
| <b>Dynamic<sup>a</sup></b>  |              |   |      |                   |       |      |    |    |
| Turn-On Delay Time  | $t_{d(on)}$  | N-Channel<br>$V_{DD} = 20\text{ V}, R_L = 4\ \Omega$<br>$I_D \cong 5\text{ A}, V_{GEN} = 10\text{ V}, R_g = 1\ \Omega$      | N-Ch |                   | 7     | 14   | ns |    |
|   |              |   | P-Ch |                   | 11    | 20   |    |    |
| Rise Time   | $t_r$        |   | N-Ch |                   | 10    | 20   |    |    |
|   |              |   | P-Ch |                   | 15    | 30   |    |    |
| Turn-Off Delay Time   | $t_{d(off)}$ | P-Channel<br>$V_{DD} = -20\text{ V}, R_L = 4\ \Omega$<br>$I_D \cong -5\text{ A}, V_{GEN} = -10\text{ V}, R_g = 1\ \Omega$   | N-Ch |                   | 15    | 30   |    |    |
|   |              |   | P-Ch |                   | 36    | 60   |    |    |
| Fall Time   | $t_f$        |   | N-Ch |                   | 9     | 18   |    |    |
|   |              |   | P-Ch |                   | 9     | 18   |    |    |
| Turn-On Delay Time  | $t_{d(on)}$  | N-Channel<br>$V_{DD} = 20\text{ V}, R_L = 4\ \Omega$<br>$I_D \cong 5\text{ A}, V_{GEN} = 4.5\text{ V}, R_g = 1\ \Omega$     | N-Ch |                   | 16    | 30   |    |    |
|   |              |   | P-Ch |                   | 49    | 80   |    |    |
| Rise Time   | $t_r$        |   | N-Ch |                   | 17    | 30   |    |    |
|   |              |   | P-Ch |                   | 79    | 120  |    |    |
| Turn-Off Delay Time   | $t_{d(off)}$ | P-Channel<br>$V_{DD} = -20\text{ V}, R_L = 4\ \Omega$<br>$I_D \cong -5\text{ A}, V_{GEN} = -4.5\text{ V}, R_g = 16\ \Omega$ | N-Ch |                   | 16    | 30   |    |    |
|   |              |   | P-Ch |                   | 35    | 60   |    |    |
| Fall Time   | $t_f$        |   | N-Ch |                   | 10    | 20   |    |    |
|   |              |   | P-Ch |                   | 14    | 25   |    |    |
| <b>Drain-Source Body Diode Characteristics</b>                                  |              |   |      |                   |       |      |    |    |
| Continuous Source-Drain Diode Current   | $I_S$        | $T_C = 25\text{ }^\circ\text{C}$  | N-Ch |                   |       | 2.5  | A  |    |
|   |              |   | P-Ch |                   |       | -2.5 |    |    |
| Pulse Diode Forward Current <sup>a</sup>  | $I_{SM}$     |   | N-Ch |                   |       | 20   |    |    |
|   |              |   | P-Ch |                   |       | -20  |    |    |
| Body Diode Voltage  | $V_{SD}$     | $I_S = 1.6\text{ A}$  | N-Ch |                   | 0.78  | 1.2  | V  |    |
|   |              | $I_S = -1.6\text{ A}$   | P-Ch |                   | -0.74 | -1.2 |    |    |
| Body Diode Reverse Recovery Time  | $t_{rr}$     | N-Channel<br>$I_F = 2\text{ A}, di/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$                           | N-Ch |                   | 19    | 30   | ns |    |
|   |              |   | P-Ch |                   | 22    | 40   |    |    |
| Body Diode Reverse Recovery Charge  | $Q_{rr}$     |   |      | N-Ch              |       | 14   | 25 | nC |
|   |              |   |      | P-Ch              |       | 22   | 35 |    |
| Reverse Recovery Fall Time  | $t_a$        | P-Channel<br>$I_F = -2\text{ A}, di/dt = -100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$                         | N-Ch |                   | 13    |      | ns |    |
|   |              |   | P-Ch |                   | 15    |      |    |    |
| Reverse Recovery Rise Time  | $t_b$        |   |      | N-Ch              |       | 6    |    |    |
|   |              |   |      | P-Ch              |       | 7    |    |    |

Notes:

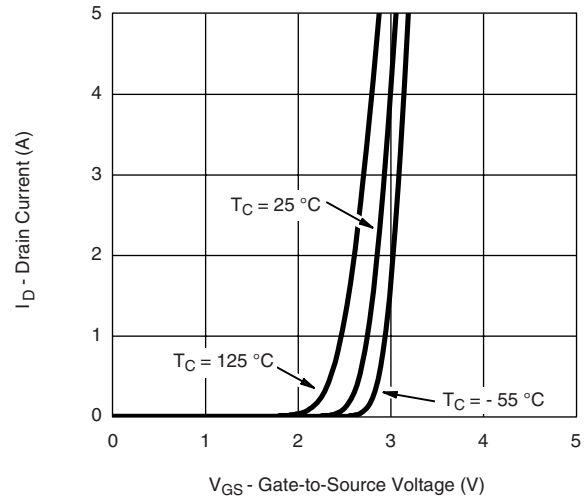
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .

*Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

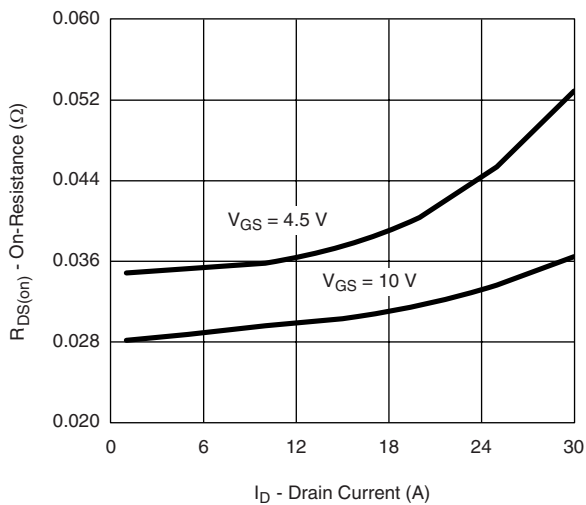
## N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



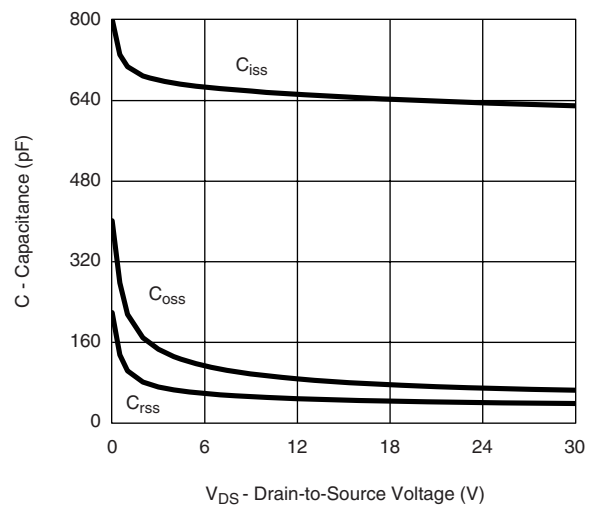
**Output Characteristics**



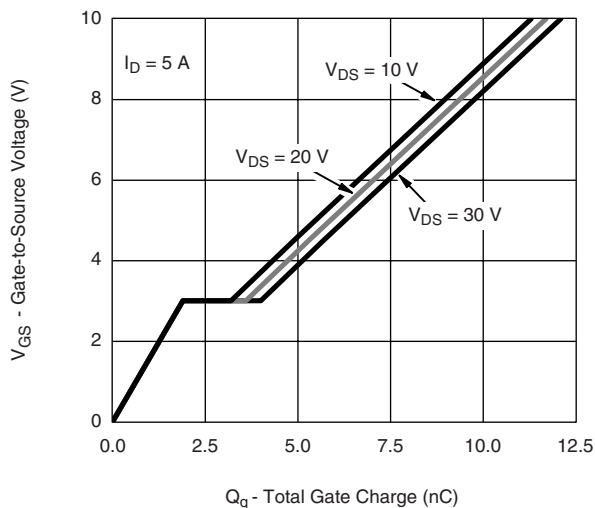
**Transfer Characteristics**



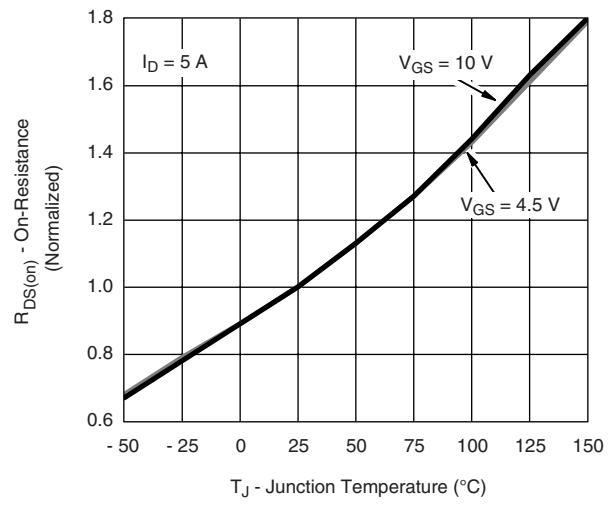
**On-Resistance vs. Drain Current**



**Capacitance**

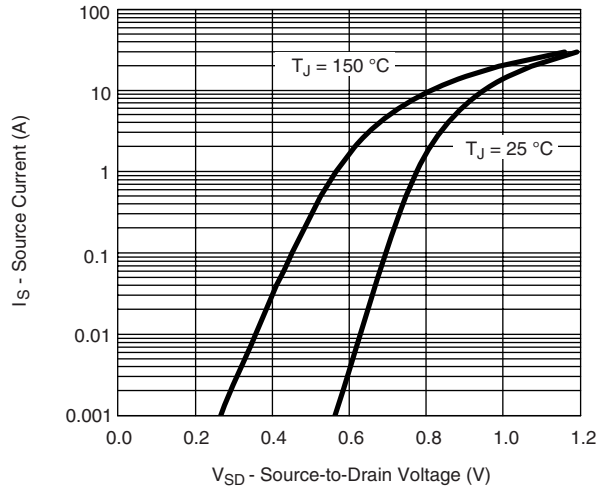


**Gate Charge**

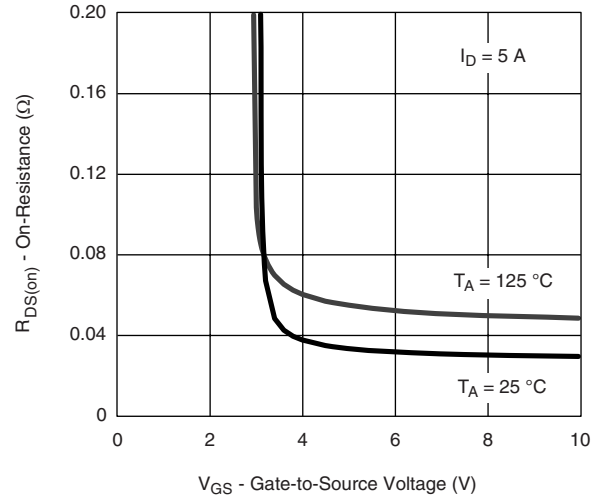


**On-Resistance vs. Junction Temperature**

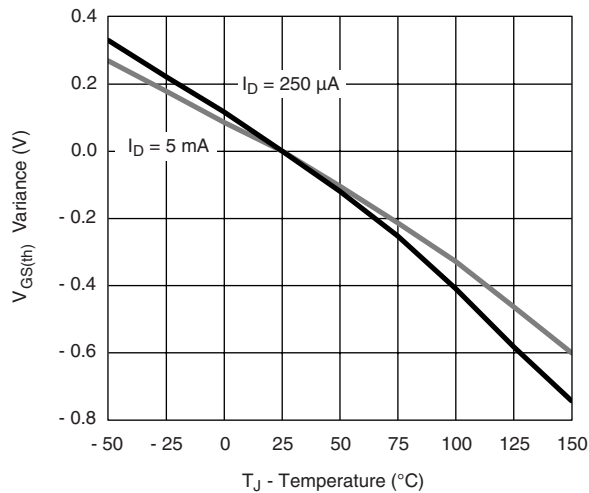
## N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



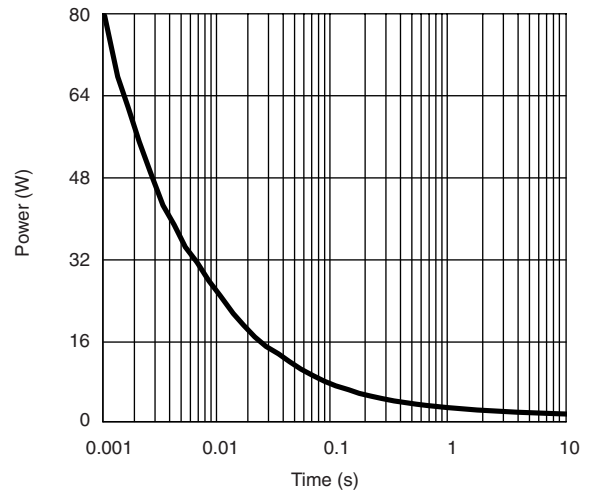
Source-Drain Diode Forward Voltage



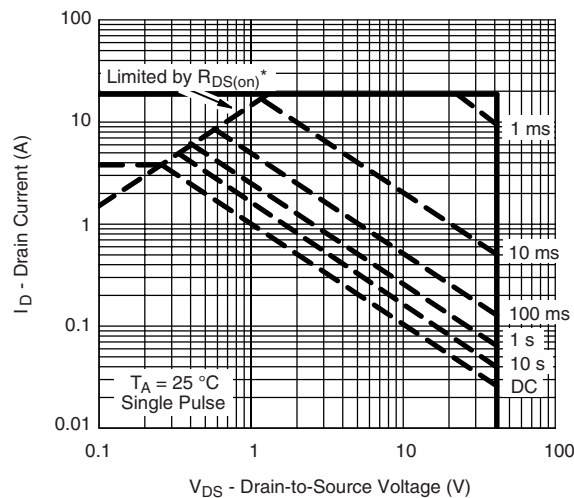
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



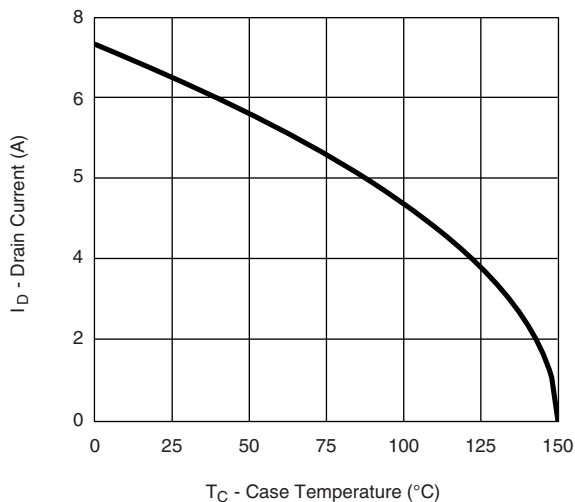
Single Pulse Power, Junction-to-Ambient



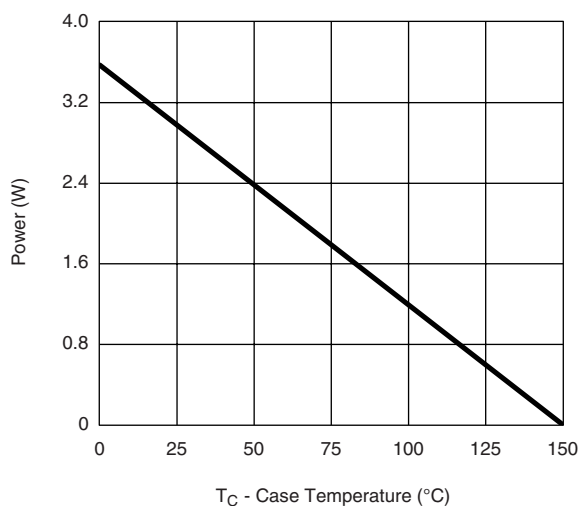
\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient

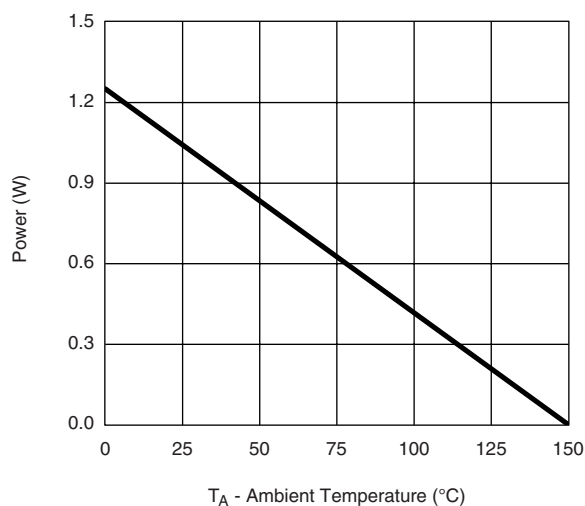
## N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



**Current Derating\***



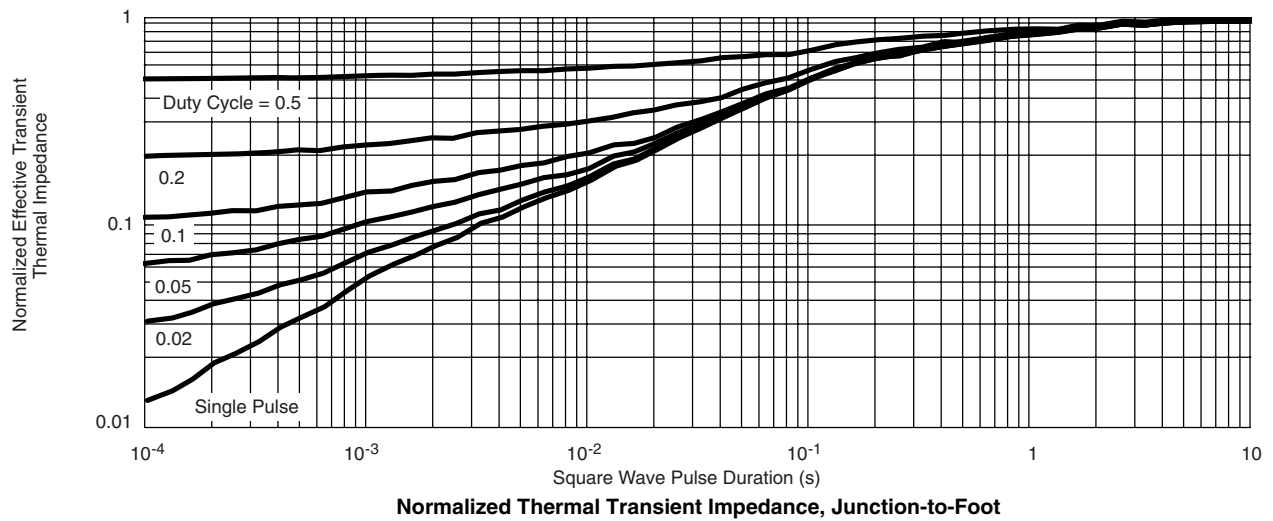
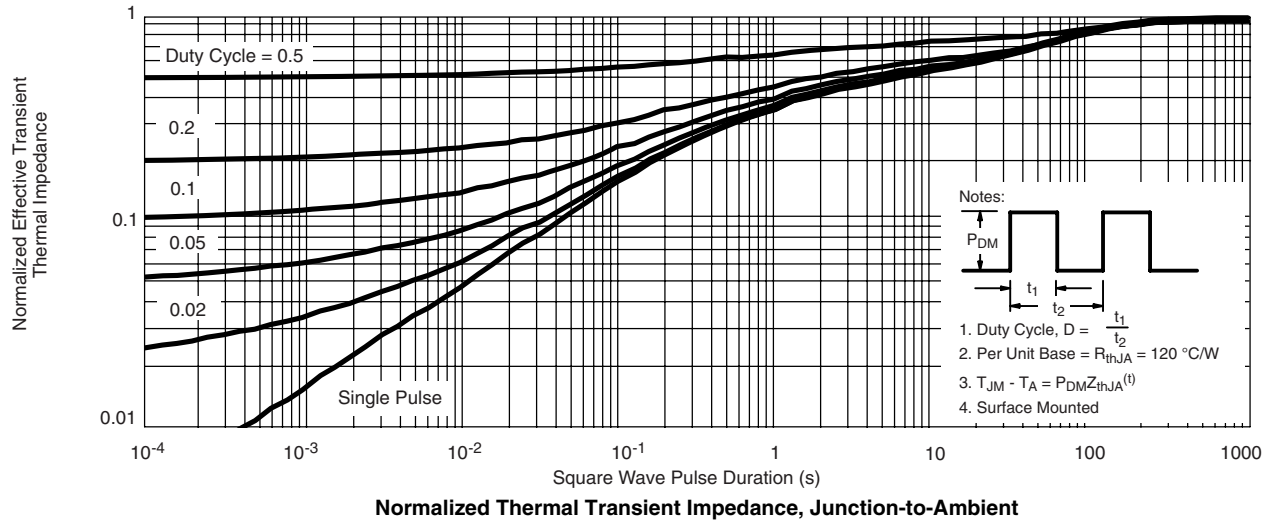
**Power Derating, Junction-to-Foot**



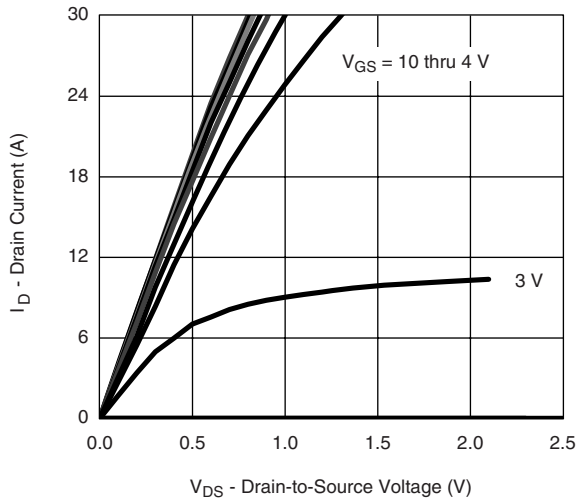
**Power Derating, Junction-to-Ambient**

\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

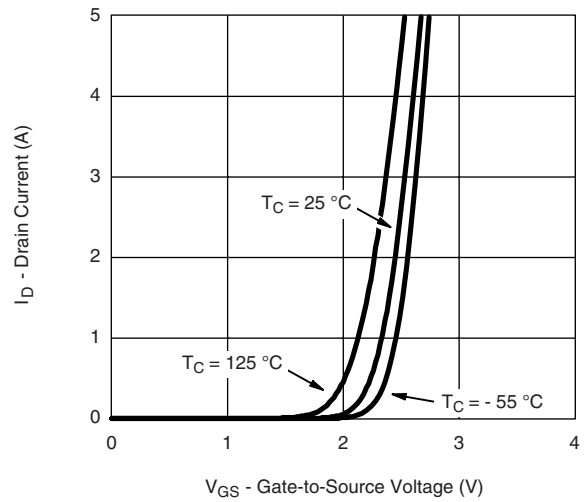
**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



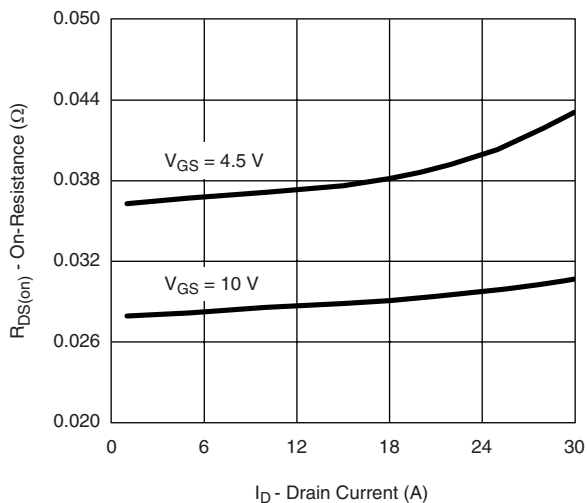
## P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



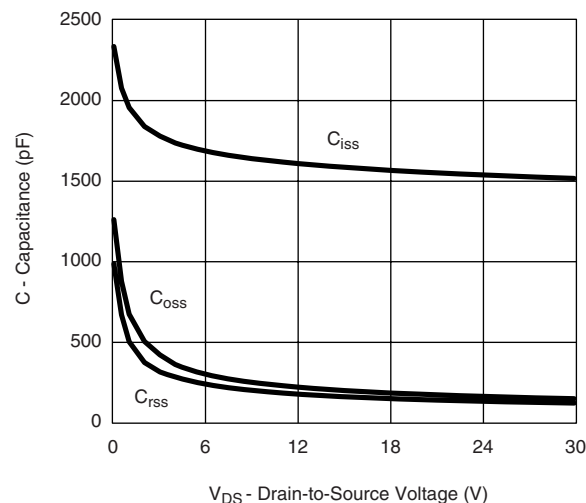
**Output Characteristics**



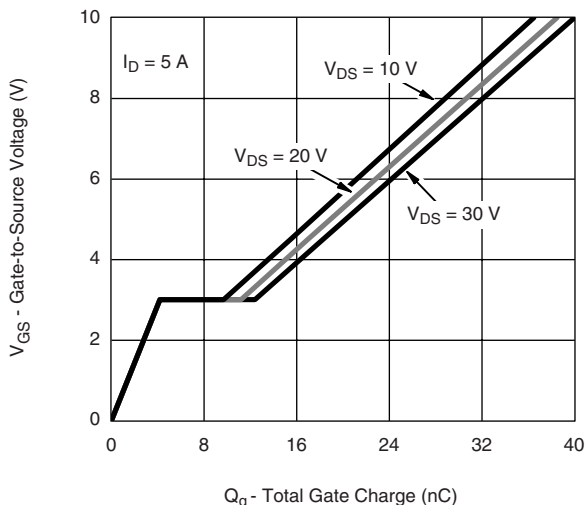
**Transfer Characteristics**



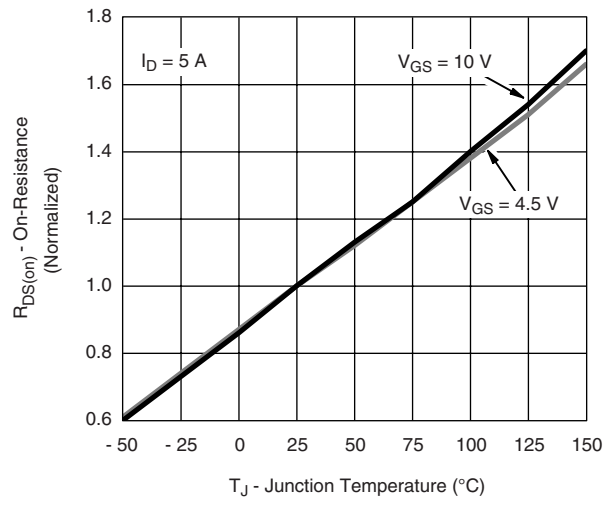
**On-Resistance vs. Drain Current**



**Capacitance**



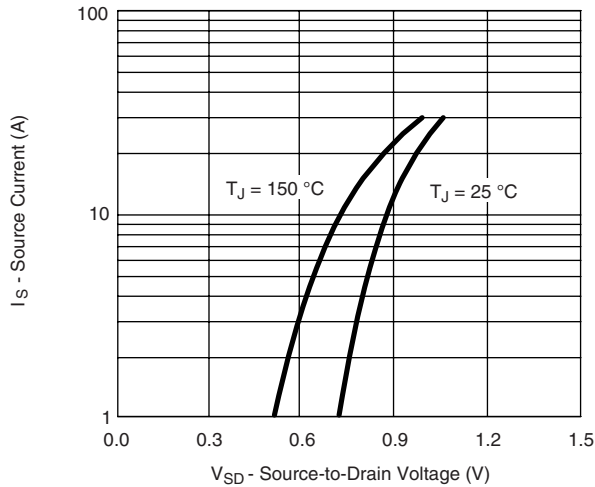
**Gate Charge**



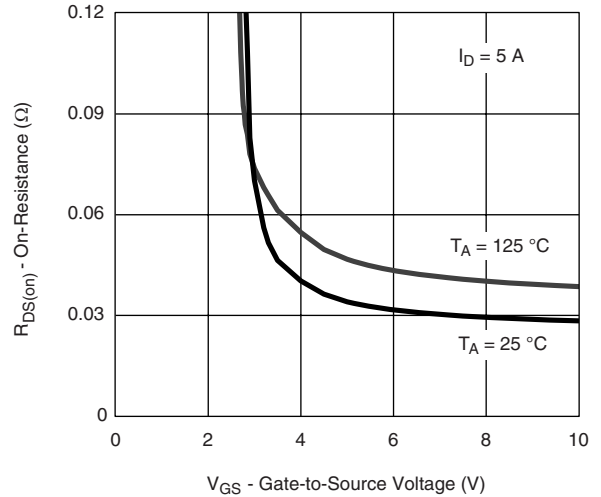
**On-Resistance vs. Junction Temperature**



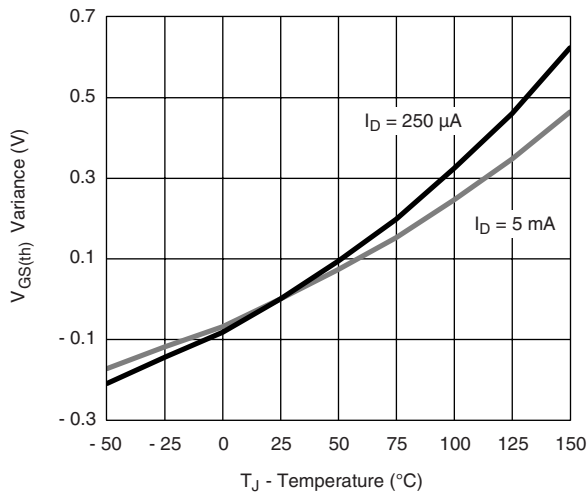
## P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



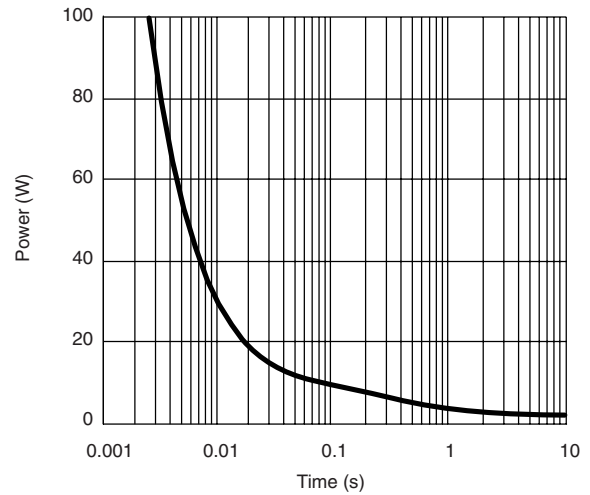
Source-Drain Diode Forward Voltage



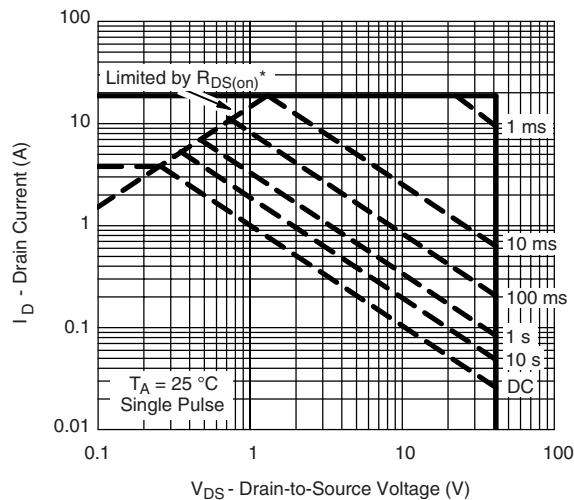
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



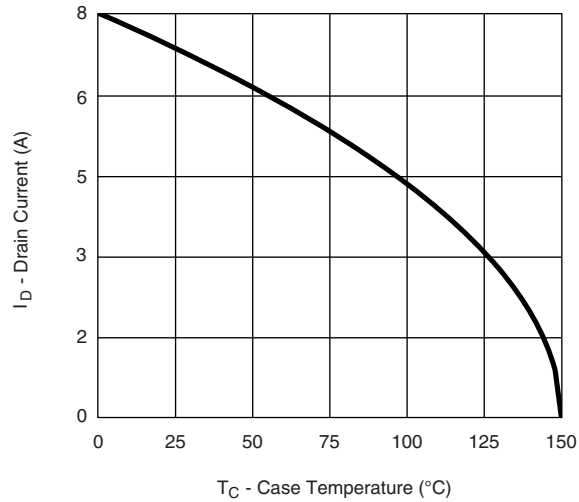
Single Pulse Power, Junction-to-Ambient



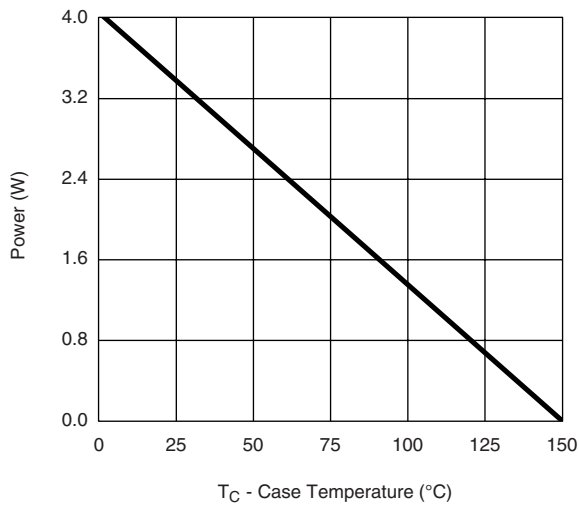
\*  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient

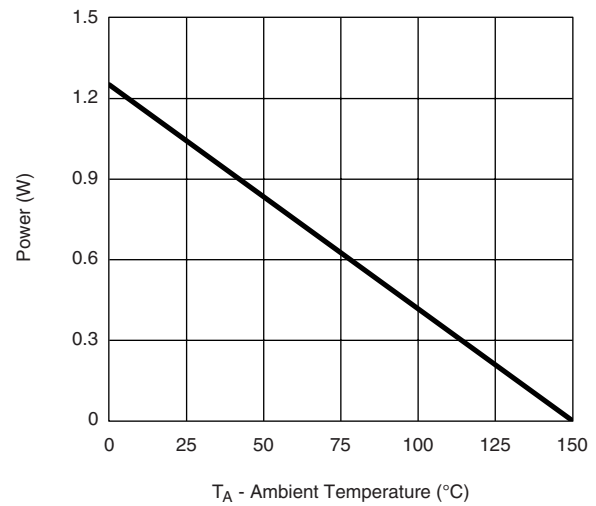
**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



**Current Derating\***



**Power Derating, Junction-to-Foot**

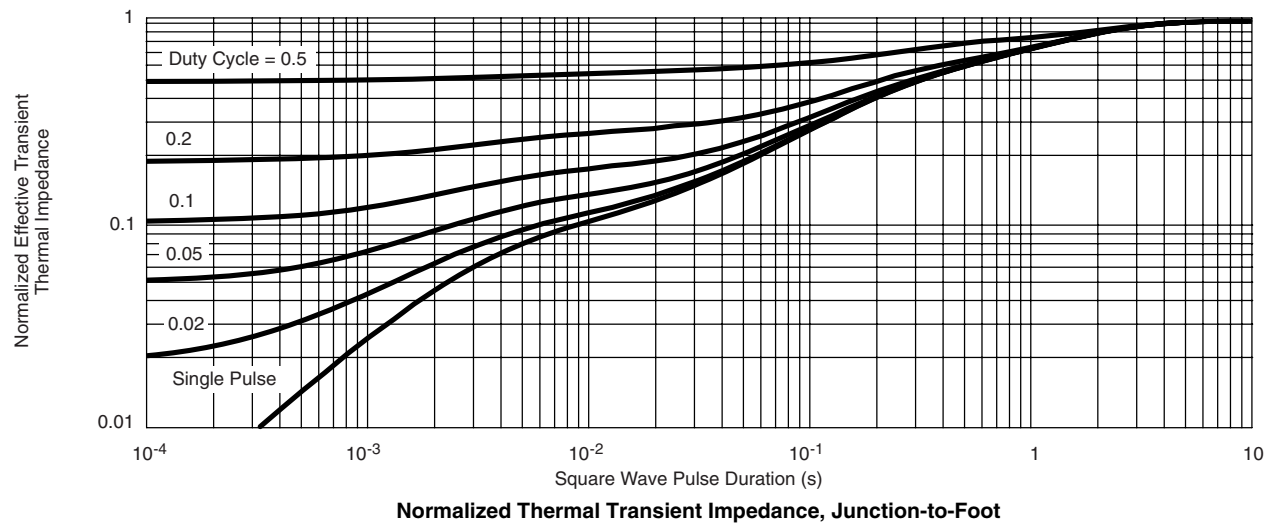
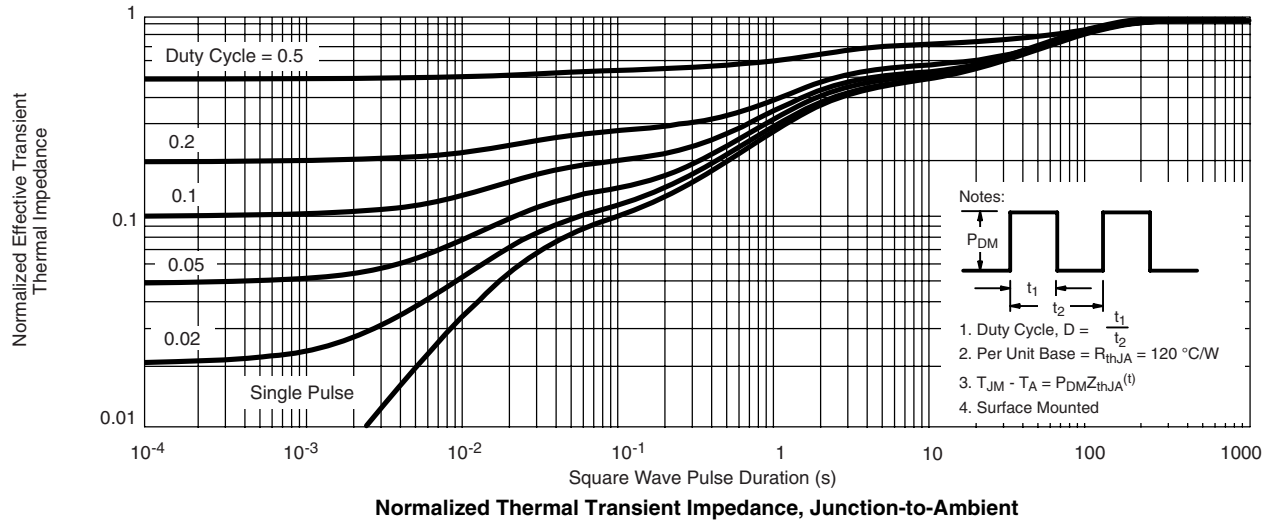


**Power Derating, Junction-to-Ambient**

\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



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